



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

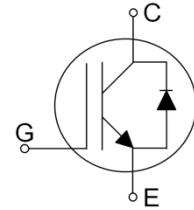
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Features:

- 1000V NPT Trench Technology
- High Speed Switching
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy parallel Operation
- RoHS compliant
- JEDEC Qualification



Applications :

Induction Heating, Soft switching application

Device	Package	Marking	Remark
GPA042A100L-ND	TO-264	GPA042A100L-ND	RoHS

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-Emitter Voltage	V_{CES}	1000	V	
Gate-Emitter Voltage	V_{GES}	± 20	V	
Continuous Current	I_c	$T_C = 25\text{ }^\circ\text{C}$	60	A
		$T_C = 100\text{ }^\circ\text{C}$	42	A
Pulsed Collector Current (Note 1)	I_{CM}	120	A	
Diode Continuous Forward Current	I_F	15	A	
Power Dissipation	P_D	$T_C = 25\text{ }^\circ\text{C}$	463	W
		$T_C = 100\text{ }^\circ\text{C}$	185	W
Operating Junction Temperature	T_J	-55 ~ 150	$^\circ\text{C}$	
Storage Temperature Range	T_{STG}	-55 ~ 150	$^\circ\text{C}$	
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$	

Notes :

(1) Repetitive rating : Pulse width limited by max junction temperature

Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.27	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	1.59	$^\circ\text{C/W}$
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	25	$^\circ\text{C/W}$

Electrical Characteristics of the IGBT $T_C=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Collector – Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0V, I_C = 1mA$	1000	--	--	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE} = 1000V, V_{GE} = 0V$	--	--	1	mA
Gate – Emitter Leakage Current	I_{GES}	$V_{CE} = 0V, V_{GE} = 20V$	--	--	± 250	nA
ON						
Gate – Emitter Threshold Voltage	$V_{GE(TH)}$	$V_{GE} = V_{CE}, I_C = 60mA$	3.5	5.5	7.5	V
Collector – Emitter Saturation Voltage	$V_{CE(SAT)}$	$V_{GE} = 15V, I_C = 60A, T_J = 25^\circ\text{C}$	--	2.3	2.9	V
		$V_{GE} = 15V, I_C = 60A, T_J = 125^\circ\text{C}$	--	2.8	--	V
DYNAMIC						
Input Capacitance	C_{IES}	$V_{CE} = 30V,$ $V_{GE} = 0V$ $f = 1MHz$	--	5600	--	pF
Output Capacitance	C_{OES}		--	150	--	pF
Reverse Transfer Capacitance	C_{RES}		--	115	--	pF
SWITCHING						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 60A$ $R_G = 50\Omega, V_{GE} = 15V$ Inductive Load, $T_J = 25^\circ\text{C}$	--	230	--	ns
Rise Time	t_r		--	210	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	1480	--	ns
Fall Time	t_f		--	125	230	ns
Turn-On Switching Loss	E_{ON}		--	13.1	20	mJ
Turn-Off Switching Loss	E_{OFF}		--	6.3	10	mJ
Total Switching Loss	E_{TS}	--	19.4	30	mJ	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 60A$ $R_G = 50\Omega, V_{GE} = 15V$ Inductive Load, $T_J = 125^\circ\text{C}$	--	200	--	ns
Rise Time	t_r		--	200	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	1670	--	ns
Fall Time	t_f		--	160	--	ns
Turn-On Switching Loss	E_{ON}		--	13.3	20	mJ
Turn-Off Switching Loss	E_{OFF}		--	7.6	11.4	mJ
Total Switching Loss	E_{TS}	--	20.9	31.4	mJ	
Total Gate Charge	Q_g	$V_{CC} = 600V, I_C = 60A$ $V_{GE} = 15V$	--	270	405	nC
Gate-Emitter Charge	Q_{ge}		--	45	68	nC
Gate-Collector Charge	Q_{gc}		--	100	150	nC

Electrical Characteristics of the DIODE $T_C=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units	
Diode Forward Voltage	V_{FM}	$I_F = 15\text{ A}$	$T_J=25^{\circ}\text{C}$	--	1.7	2.2	V
			$T_J=125^{\circ}\text{C}$	--	1.8	--	
Diode Forward Voltage	V_{FM}	$I_F = 60\text{ A}$	$T_J=25^{\circ}\text{C}$	--	2.9	3.4	V
			$T_J=125^{\circ}\text{C}$	--	3.3	--	
Reverse Recovery Time	t_{rr}	$I_F = 60\text{ A},$ $di/dt=200\text{A/us}$	$T_J=25^{\circ}\text{C}$	--	310	465	ns
			$T_J=125^{\circ}\text{C}$	--	320	--	
Reverse Recovery Current	I_{rr}	$I_F = 60\text{ A},$ $di/dt=200\text{A/us}$	$T_J=25^{\circ}\text{C}$	--	34	51	A
			$T_J=125^{\circ}\text{C}$	--	35	--	
Reverse Recovery Charge	Q_{rr}	$I_F = 60\text{ A},$ $di/dt=200\text{A/us}$	$T_J=25^{\circ}\text{C}$	--	5270	7900	nC
			$T_J=125^{\circ}\text{C}$	--	5600	--	

IGBT Characteristics

Fig. 1 Output characteristics

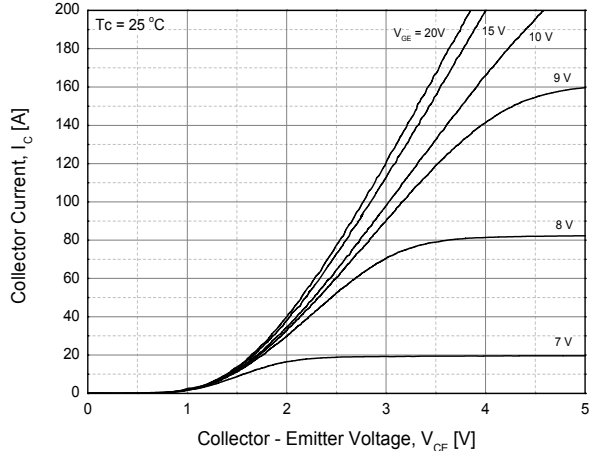


Fig. 2 Saturation voltage characteristics

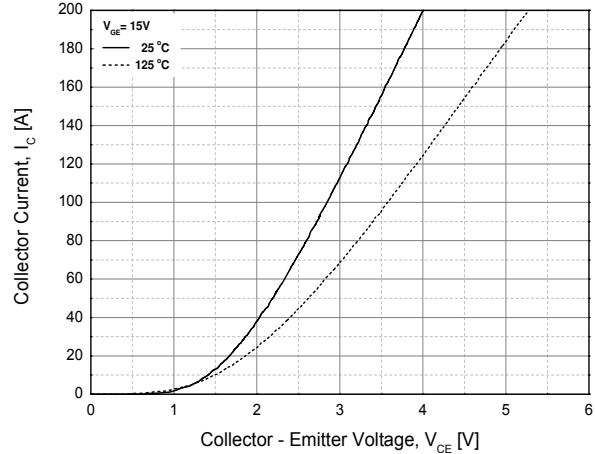


Fig. 3 Saturation voltage vs. collector current

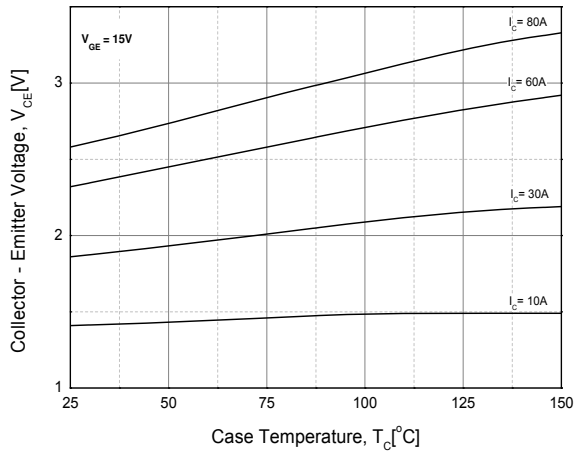


Fig. 4 Saturation voltage vs. gate bias

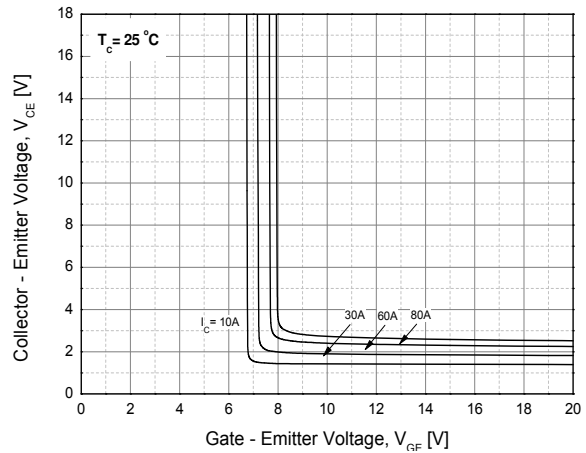


Fig. 5 Saturation voltage vs. gate bias

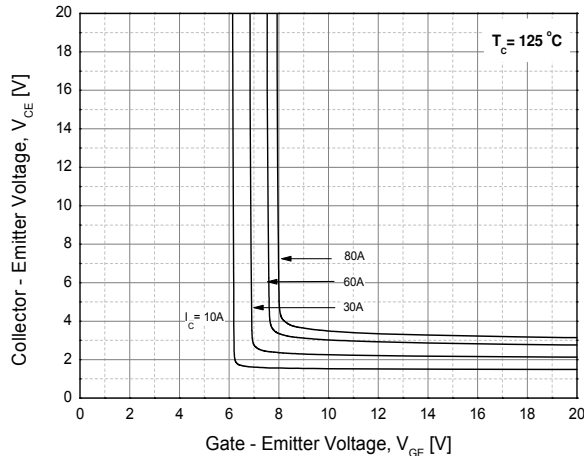
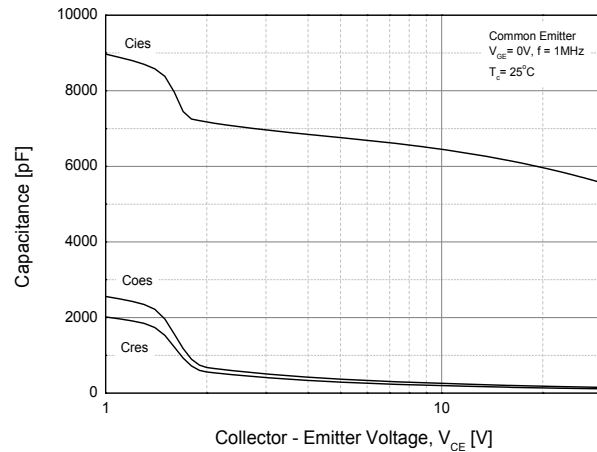


Fig. 6 Capacitance characteristics



IGBT Characteristics

Fig. 7 Turn on time vs. gate resistance

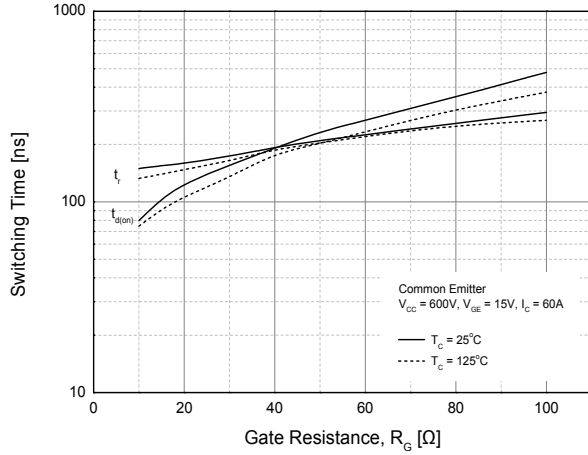


Fig. 8 Turn off time vs. gate resistance

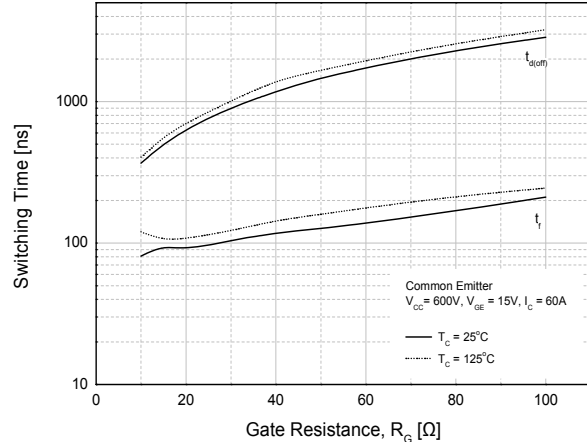


Fig. 9 Switching loss vs. gate resistance

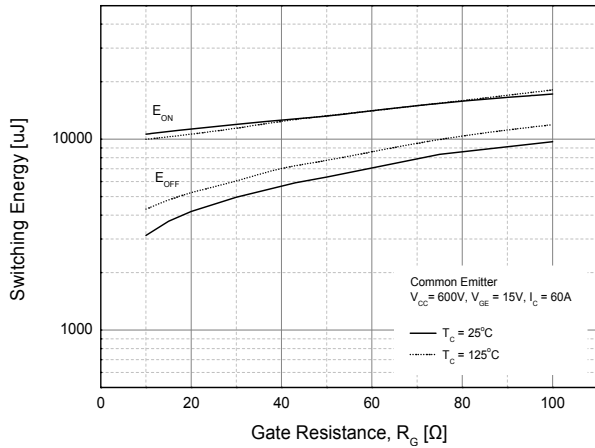


Fig. 10 Turn on time vs. collector current

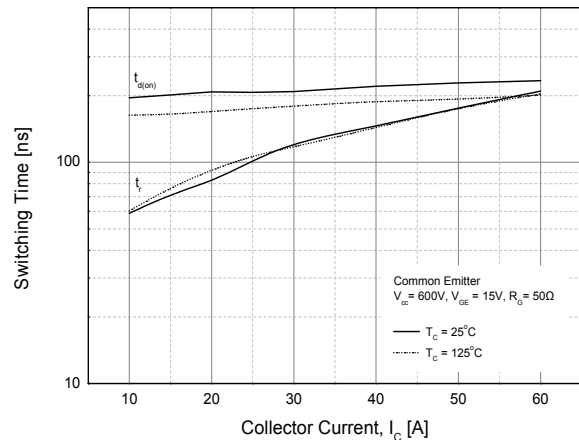


Fig. 11 Turn off time vs. collector current

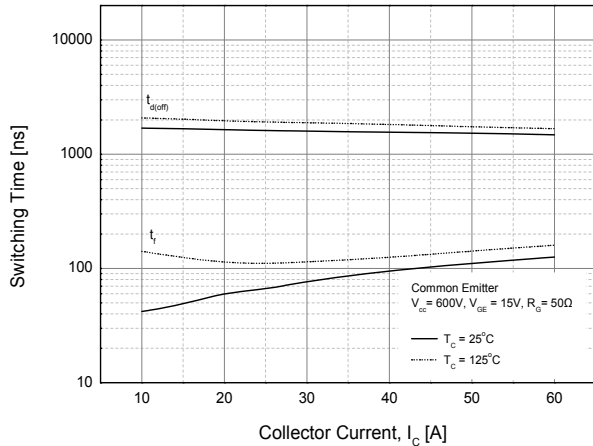
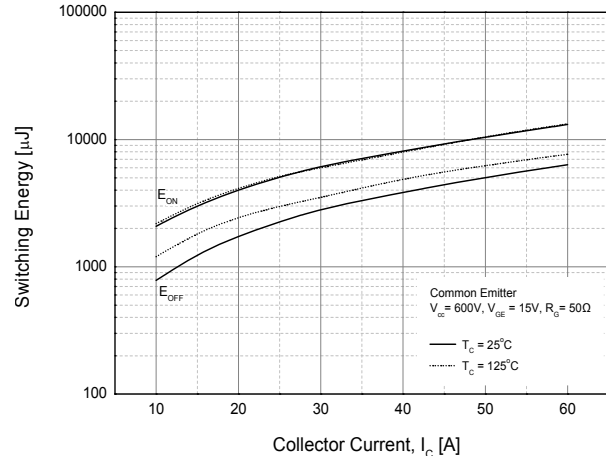


Fig. 12 Switching loss vs. collector current



IGBT Characteristics

Fig. 13 Gate charge characteristics

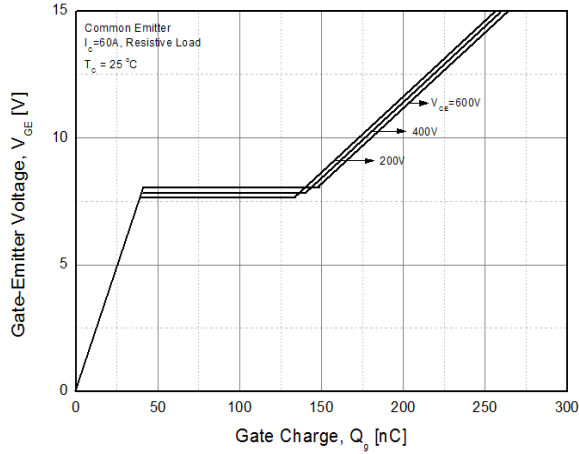


Fig. 14 SOA

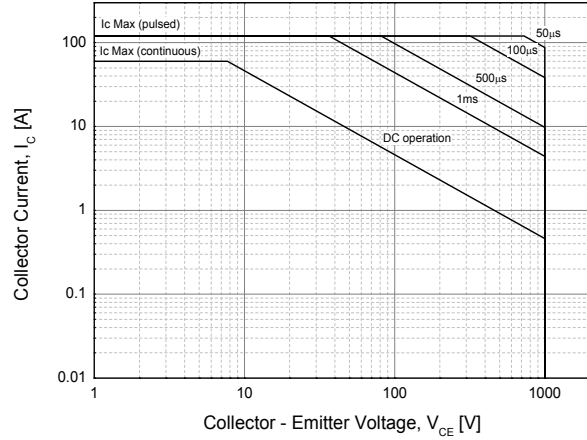


Fig. 15 RBSOA

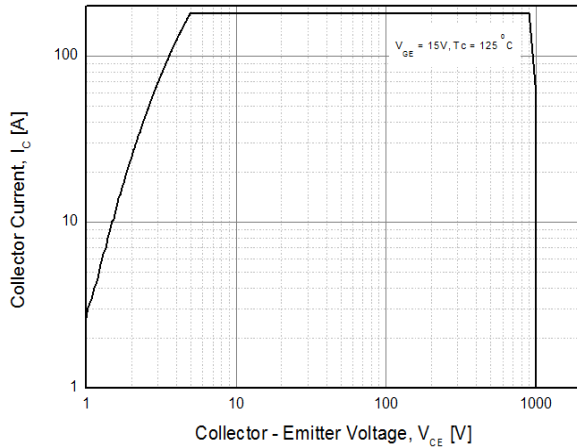


Fig. 16 Transient thermal impedance

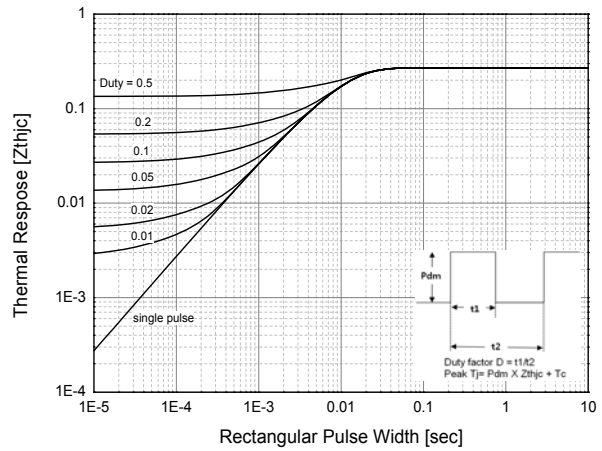
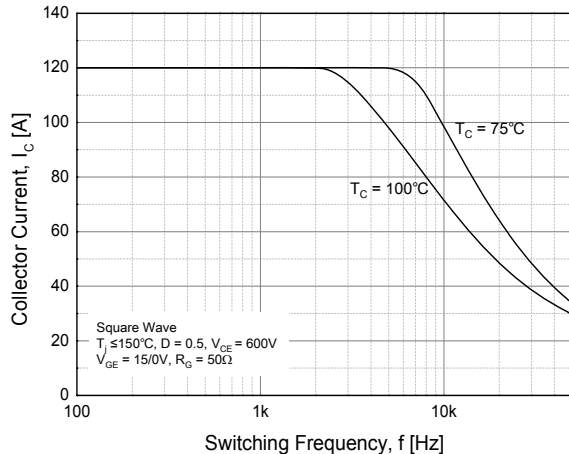


Fig. 17 Load Current vs. Frequency



Diode Characteristics

Fig. 18 Conduction characteristics

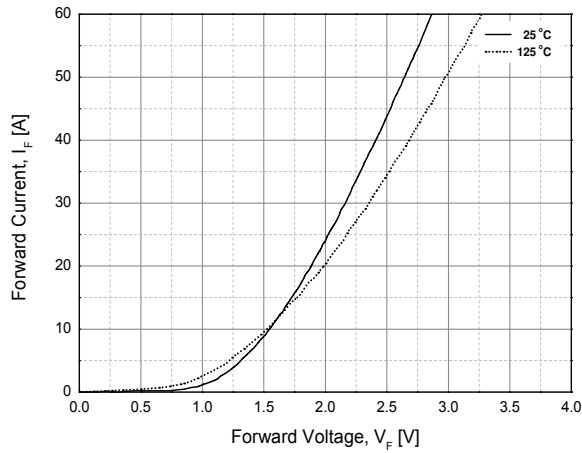


Fig. 19 Reverse recovery current vs. forward current

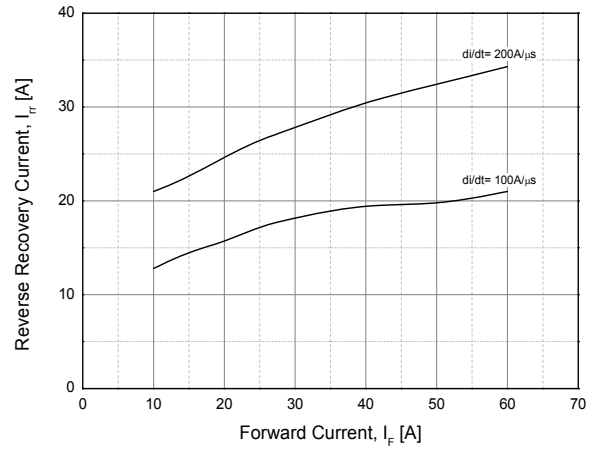


Fig. 20 Stored recovery charge vs. forward current

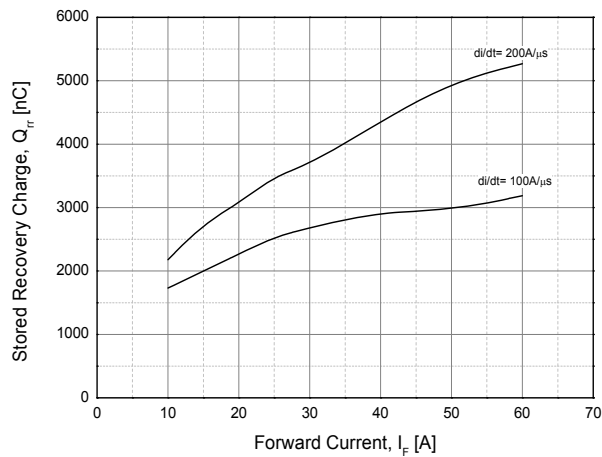
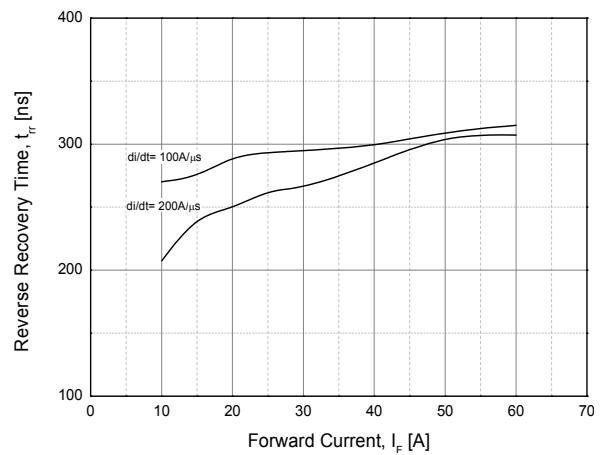
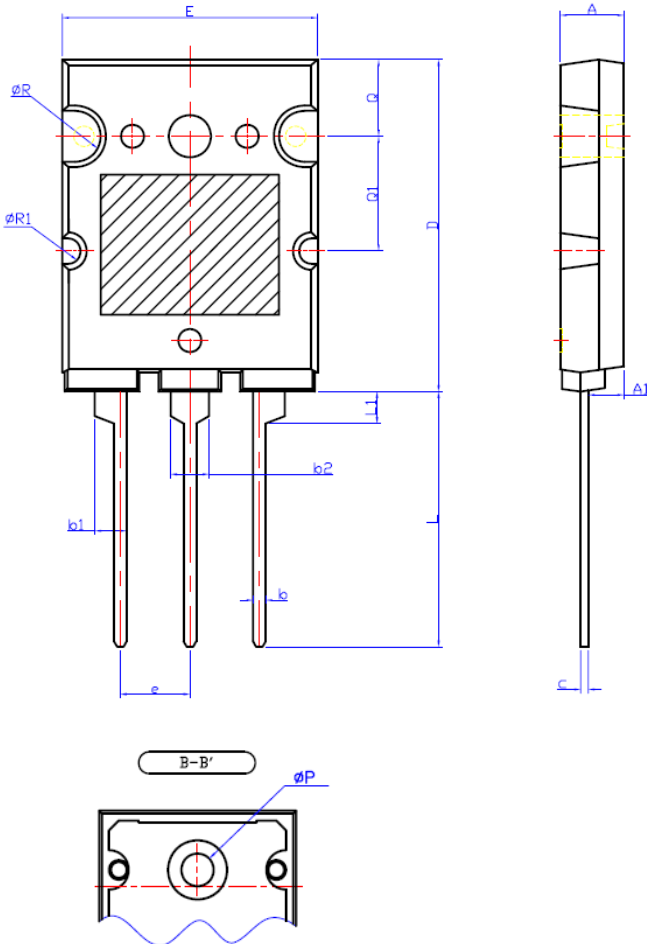


Fig. 21 Reverse recovery time vs. forward current



Package Dimension : TO-264



SYMBOL	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.50	2.80	3.10
b	0.90	1.00	1.25
b1	2.30	2.50	2.70
b2	2.80	3.00	3.20
c	0.50	0.60	0.85
D	25.80	26.00	26.20
E	19.80	20.00	20.20
e	5.15	5.45	5.75
L	19.50	20.00	20.50
L1	2.40	2.50	2.60
ϕP	3.00	3.20	3.40
Q	5.80	6.00	6.20
Q1	8.80	9.00	9.20
ϕR	(2.00)		
$\phi R1$	(1.00)		

Notes

- **RoHS Compliance**
The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.gptechgroup.com.
- **REACH Compliance**
REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at GPTG Headquarters in Lake Forest, California to insure you get the most up-to-date REACH SVHC Declaration.
REACH banned substance information (REACH Article 67) is also available upon request.
- This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control.
- To obtain additional technical information or to place an order for this product, please contact us. The information in this datasheet is provided by Global Power Technologies Group. GPTG reserves the right to make changes, corrections, modifications, and improvements of datasheet without notice.

Global Power Technologies Group

20692 Prism Place
Lake Forest, CA 92630
TEL (949) 207-7500
FAX (949) 613-7600
E-mail: info@gptechgroup.com
Web site: www.gptechgroup.com

